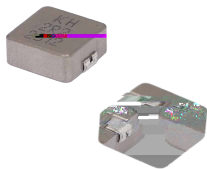


MDSA Series
SMD Low Profile High Current Molded Inductor
Size 1050



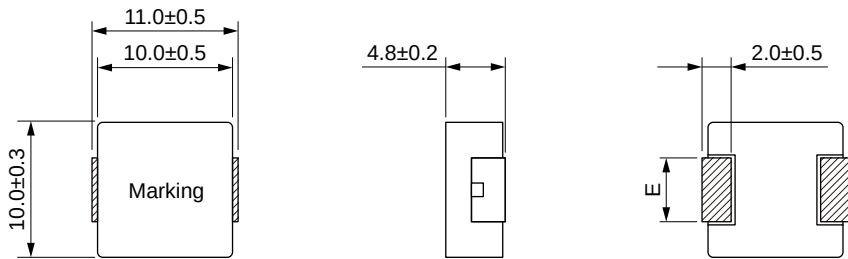
FEATURES

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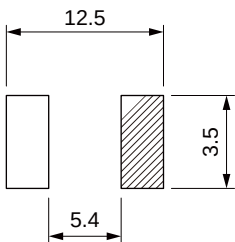
APPLICATION

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-

Dimensions: [mm]



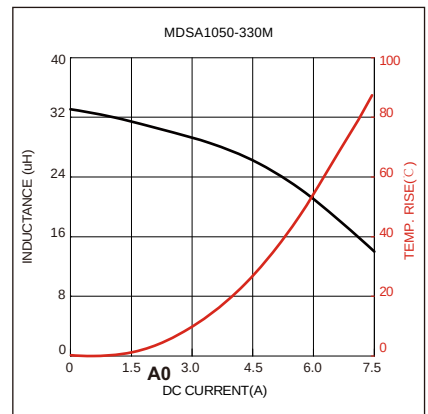
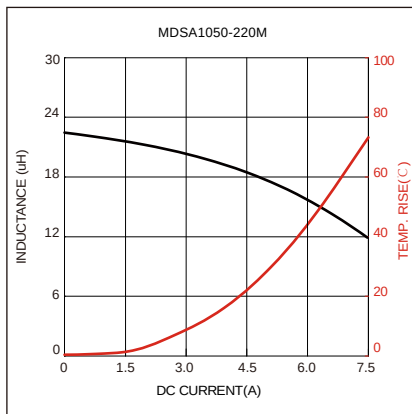
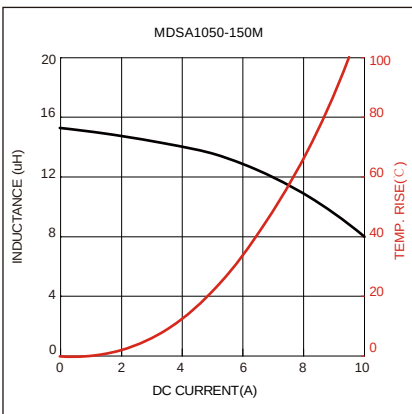
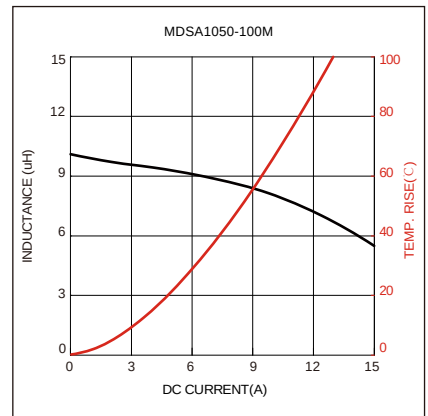
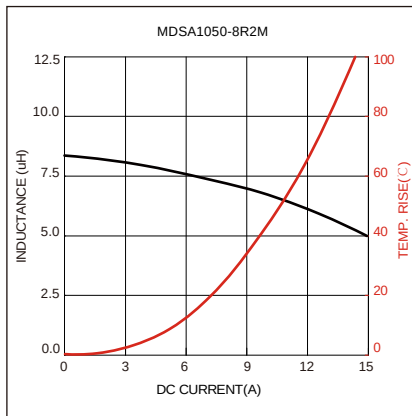
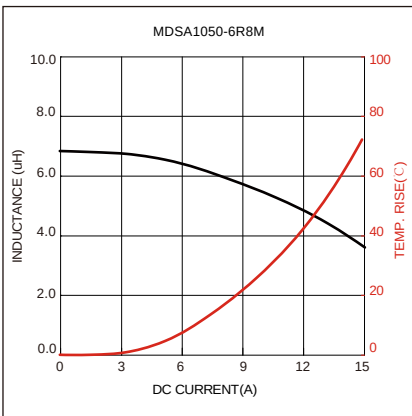
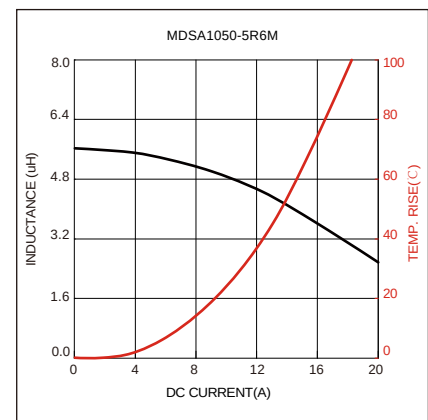
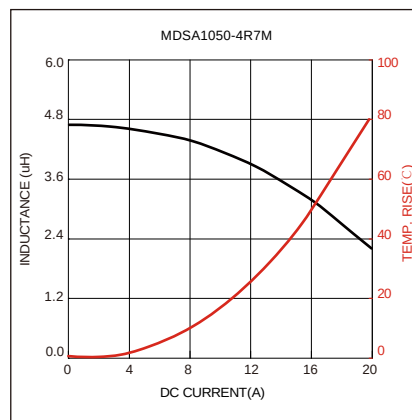
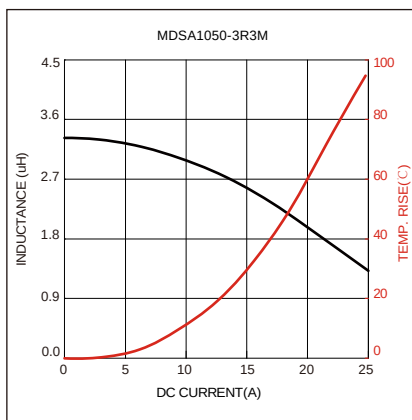
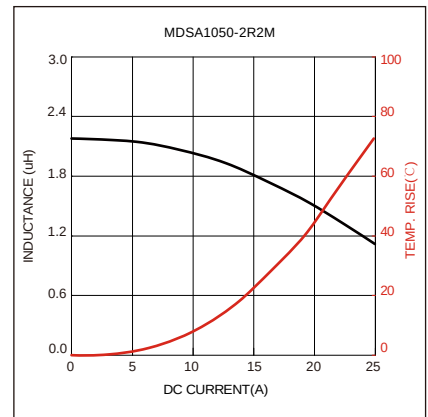
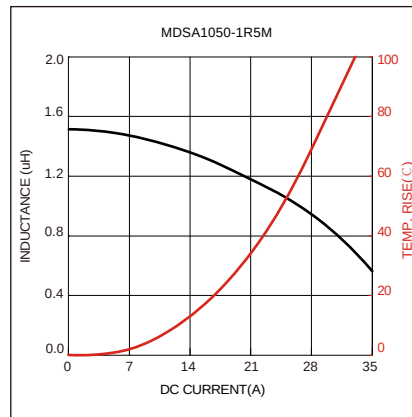
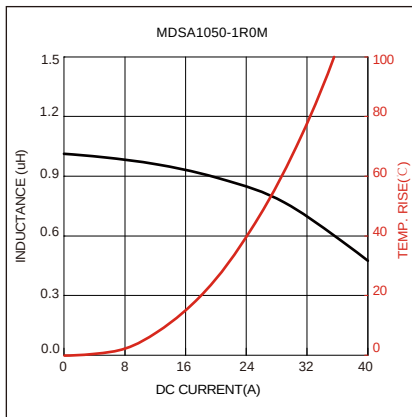
Land Pattern: [mm]



Electrical Properties:

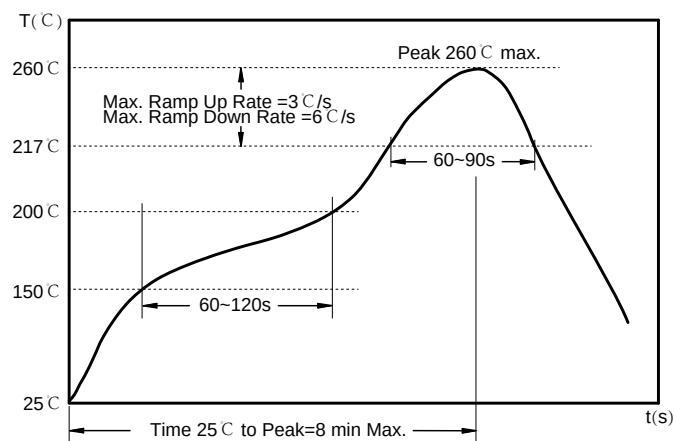
Saturation Current will cause L to drop approximately 30%
 Temperature Rise Current: The actual value of DC current when the temperature rise is $\Delta T=40^{\circ}\text{C}$

Typical Electrical Characteristics:





Soldering Reflow:



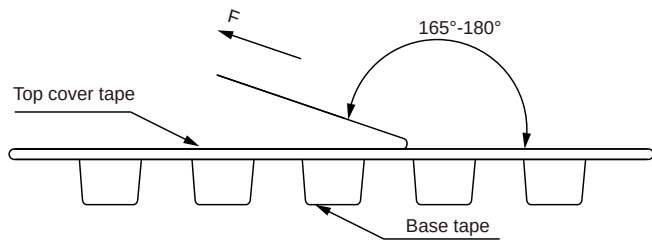
Preheat condition: $150 \sim 200^{\circ}\text{C}$ / 60~120 sec.
Allowed time above 217°C : 60~90 sec.
Max temperature: 260°C .
Max time at max temperature: 10 sec.
Allowed Reflow time: 2x max.

Packaging Information:

Tape Dimension:

Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDSA1050	10.4 ± 0.1	11.6 ± 0.1	1.5 ± 0.1	4.0 ± 0.1	16.0 ± 0.1	24.0 ± 0.3	5.4 ± 0.1	1.75 ± 0.1	0.40 ± 0.05

Peel force of top cover tape:

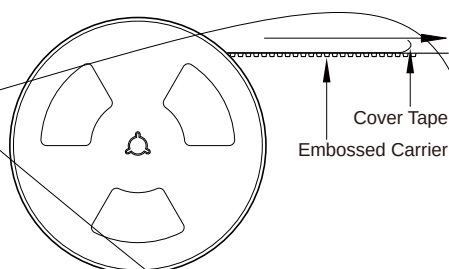


The peel force of top cover tape shall be between 0.1 to 1.3 N

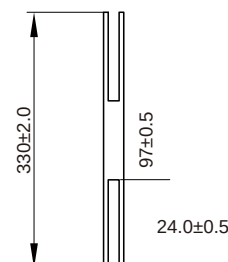
Product Marking:

Marking	KH+Printing (Inductance)
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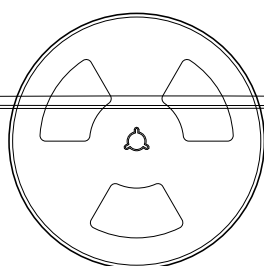
Reel Dimension: [mm]



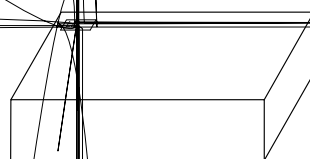
2.2±0.5



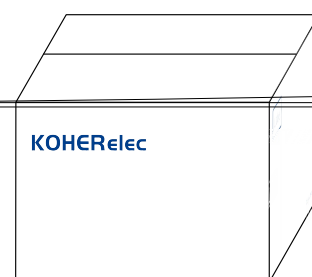
Packaging Quantity:



500 Pcs/Reel



2 Reel / Inner box(1000 Pcs)



3 Inner box/Carton box(3K Pcs)

Cautions and Warnings:

Storage Conditions:

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. The warranty period is one year.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer does. As a result customer shall be responsible for checking and confirming whether Koher product with the performance described in the product specification is suitable for using in customer's particular application or not.